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[File 351] **Derwent WPI** 1963-2008/UD=200804

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**File 351: English-language translations of Chinese Utility Model registrations are available starting with update 200769.*

JP 2125654

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Semiconductor capacitor element - has polysilicon layer formed on spaced insulator layers within island on semiconductor substrate NoAbstract Dwg 1/3

Patent Assignee: NEC CORP (NIDE)

Inventor: OKIZAKI H

Patent Family (1 patents, 1 countries)

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|---------------|------|----------|--------------------|------|----------|--------|------|
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Class Codes

International Patent Classification

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|---------------|-------------|-------|----------|--------|--------------|
| H01L-0021/822 | A | I | L | R | 20060101 |
| H01L-0027/04 | A | I | F | R | 20060101 |
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SEMICONDUCTOR CAPACITANCE ELEMENT

Assignee: NEC CORP (NIDE)

Inventor: OKIZAKI HIROAKI

Language: JA

Application: JP 1988279716 A 19881104 (Local application)

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